2-1761607-3 ACTIVE

AMP-LATCH

TE Internal #: 2-1761607-3

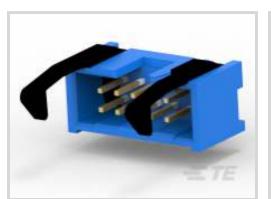
Ribbon Cable Connectors, Wire-to-Board, 10 Position, 2.54 mm [.1 in] Centerline, Right Angle, Through Hole - Solder, 2 Row, Plug,

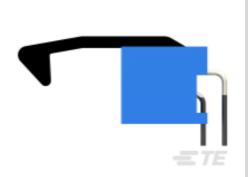
Low Profile

View on TE.com >

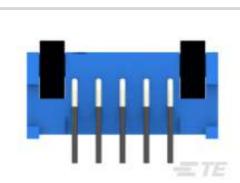


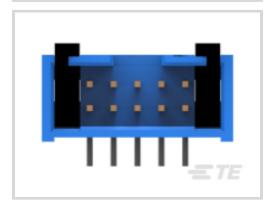
Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors











Connector System: Wire-to-Board

Number of Positions: 10

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Retention: Without

PCB Mount Orientation: Right Angle

Features

Product Type Features

Troduct Type realures	
Ribbon Cable Connector Header Type	Pin Header
Connector Product Type	Connector Assembly
Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	10
PCB Mount Orientation	Right Angle
Number of Rows	2
Electrical Characteristics	
Insulation Resistance	5000 MΩ
Operating Voltage	250 VAC

With

Body Features

Daisy Chain



Primary Product Color Connector Profile Low Contact Features PCB Contact Termination Area Plating Material Thickness PCB Contact Termination Area Plating Material Thickness Add mm[.025 in] Contact Type Pin Contact Mating Area Plating Material Thickness .762 µm[30 µin] Contact Mating Area Plating Material Contact Shape & Form Square Contact Underplating Material Nickel PCB Contact Termination Area Plating Material	
Contact Features PCB Contact Termination Area Plating Material Thickness 2.54 μm[100 μin] Mating Pin Diameter .64 mm[.025 in] Contact Type Pin Contact Mating Area Plating Material Thickness .762 μm[30 μin] Contact Mating Area Plating Material Gold Flash Contact Shape & Form Square Contact Underplating Material Nickel	
PCB Contact Termination Area Plating Material Thickness 2.54 μm[100 μin] Mating Pin Diameter .64 mm[.025 in] Contact Type Pin Contact Mating Area Plating Material Thickness .762 μm[30 μin] Contact Mating Area Plating Material Gold Flash Contact Shape & Form Square Contact Underplating Material Nickel	
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Contact Mating Area Plating Material Contact Shape & Form Square Contact Underplating Material Nickel	
Contact Shape & Form Square Contact Underplating Material Nickel	
Contact Underplating Material Nickel	
PCB Contact Termination Area Plating Material Tin	
Contact Base Material Phosphor Bronze	
Contact Current Rating (Max) 1 A	
Termination Features	
Round Termination Post & Tail Diameter .64 mm[.025 in]	
Termination Post & Tail Length 2.6 mm[.102 in]	
Termination Method to Printed Circuit Board Through Hole - Solder	
Mechanical Attachment	
Mating Alignment With	
PCB Mount Alignment Without	
Panel Mount Feature Without	
PCB Mount Retention Without	
Mating Alignment Type Center	
Mating Retention With	
Mating Retention Type Ejection Latch	
Connector Mounting Type Board Mount	
Housing Features	
Mating Entry Location Top	
Housing Material PBT	
Centerline (Pitch) 2.54 mm[.1 in]	
Dimensions	
Shrouded End Dimension 3.76 mm[.148 in]	



Connector Length	20.32 mm[.8 in]
Connector Height	9.19 mm[.36 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	26
Packaging Method	Tube
Other	

Product Compliance

For compliance documentation, visit the product page on TE.com>

Wire-to-Board Connector Comment

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

For Use With AMP-Latch Receptacle

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous



materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





























Customers Also Bought





TE Part #2-1761607-9
IDC LOW PRO HDR 26P RA LG LAT



TE Part #825440-7

MOD 2 PINHDR 2X07P.

TE Part #5530843-7

CONN SEC II 30 POS 100C/L





TE Part #4-2176089-7 RP 1J 0.166W 34K 0.1% 25PPM 1K RL



TE Part #354062-E SMCB 16 F AB VV 7-03 CL * H007 137 E002



Documents

Product Drawings

IDC LOW PRO HDR 10P RA LG LAT

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-1761607-3_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2-1761607-3_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2-1761607-3_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Product Specification

English

Product Environmental Compliance

Product Compliance

English

Product Compliance

English

Ribbon Cable Connectors, Wire-to-Board, 10 Position, 2.54 mm [.1 in] Centerline, Right Angle, Through Hole - Solder, 2 Row, Plug, Low Profile



Agency Approvals
UL Report

English